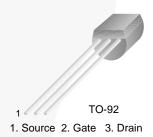


November 2013

2N7000BU / 2N7000TA Advanced Small-Signal MOSFET

Features

- · Fast Switching Times
- · Improved Inductive Ruggedness
- · Lower Input Capacitance
- · Extended Safe Operating Area
- · Improved High-Temperature Reliability



Description

These N-channel enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. These products minimize onstate resistance while providing rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 400 mA DC and can deliver pulsed currents up to 2 A. These products are particularly suited for low-voltage, low-current applications, such as small servo motor control, power MOSFET gate drivers, and other switching applications.

Ordering Information

| Part Number | Number Marking Package | | Packing Method | |
|-------------|------------------------|----------|----------------|--|
| 2N7000BU | 2N7000 | TO-92 3L | Bulk | |
| 2N7000TA | 2N7000 | TO-92 3L | Ammo | |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_C = 25^{\circ}C$ unless otherwise noted.

| Symbol | Parameter | Value | Unit | |
|----------------------------------|--|------------|------|--|
| V _{DSS} | Drain-to-Source Voltage | 60 | V | |
| | Continuous Drain Current (T _C = 25°C) | | mΛ | |
| ID | Continuous Drain Current (T _C = 100°C) | 110 | mA | |
| I _{DM} | Drain Current Pulsed ⁽¹⁾ | 1000 | mA | |
| V _{GS} | Gate-to-Source Voltage | ±30 | V | |
| T _{J,} T _{STG} | Operating Junction and Storage Temperature Range | -55 to 150 | °C | |
| T _L | Maximum Lead Temperature for Soldering Purposes, 1/8-inch from Case for 5 Seconds | | °C | |

1

Note:

1. Repetitive rating: pulse width limited by maximum junction temperature.

Thermal Characteristics(2)

Values are at $T_C = 25$ °C unless otherwise noted.

| Symbol | Parameter | Value | Unit |
|-----------------|---|-------|-------|
| В | Total Power Dissipation (T _C = 25°C) | 400 | mW |
| P_{D} | Linear Derating Factor | 3.2 | mW/°C |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 312.5 | °C/W |

Note:

2. Device mounted on FR-4 PCB, board size = 101.5 mm x 114.5 mm.

Electrical Characteristics

Values are at $T_C = 25$ °C unless otherwise noted.

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|---------------------|---|---|------|------|------|------|
| BV _{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 60 | | | V |
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$ | 0.3 | | 3.9 | V |
| | Gate Threshold Voltage | $V_{DS} = V_{GS}$, $I_D = 1 \text{ mA}$ | 0.4 | | 2.2 | |
| 1 | Gate-Source Leakage, Forward | V _{GS} = 15 V | | | 100 | nA |
| I _{GSS} | Gate-Source Leakage, Reverse | V _{GS} = -15 V | | | -100 | |
| I _{DSS} | Drain-to-Source Leakage Current | V _{DS} = 60 V | | | 1 | μА |
| | | $V_{DS} = 45 \text{ V}, T_{C} = 125^{\circ}\text{C}$ | | | 1000 | |
| R _{DS(ON)} | Static Drain-Source On-State Resistance ⁽³⁾ | V _{GS} = 10 V, I _D = 0.5 A | | | 5.0 | Ω |
| 9 _{fs} | Forward Transconductance ⁽³⁾ | $V_{DS} = 15 \text{ V}, I_{D} = 0.5 \text{ A}$ | 0.1 | 0.3 | | S |
| C _{iss} | Input Capacitance | | | 30 | | pF |
| C _{oss} | Output Capacitance | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 12 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 3.0 | | pF |
| t _{d(on)} | Turn-On Delay | | | | 10 | ns |
| t _r | Rise Time | $V_{DD} = 30 \text{ V}, I_{D} = 0.5 \text{ A},$ $R_{G} = 15 \Omega^{(3),(4)}$ | | | 10 | ns |
| t _{d(off)} | Turn-Off Delay | $R_G = 15 \Omega^{(3),(4)}$ | / | | 10 | ns |
| t _f | Fall Time | | | | 10 | ns |

Notes:

- 3. Pulse test: pulse width = 250 μ s, duty cycle \leq 2%.
- 4. Essentially independent of operating temperature.

Physical Dimensions

TO-92

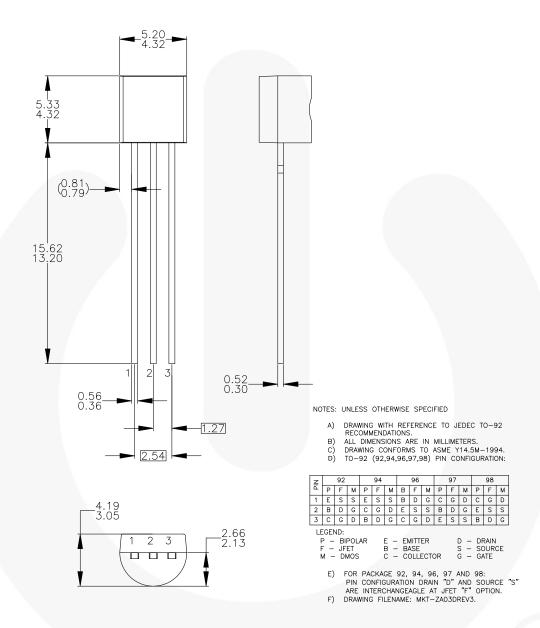


Figure 1. 3-LEAD, TO-92, JEDEC TO-92 COMPLIANT STRAIGHT LEAD CONFIGURATION

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/dwg/ZA/ZA03D.pdf.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: http://www.fairchildsemi.com/packing_dwg/PKG-ZA03D_BK.pdf.

Physical Dimensions (Continued)

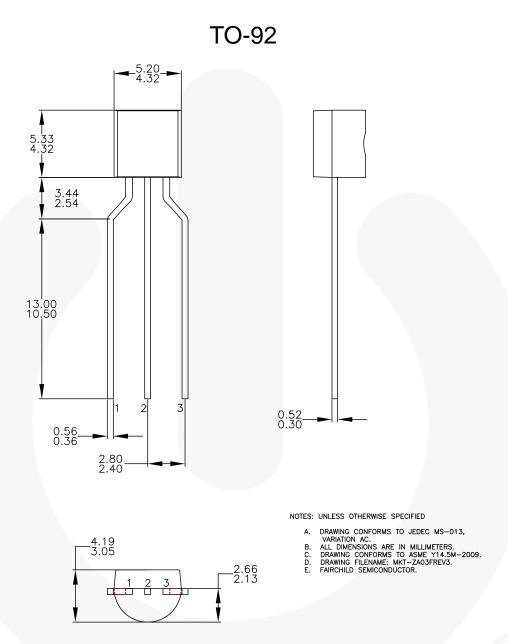


Figure 2. 3-LEAD, TO-92, MOLDED 0.200 IN LINE SPACING LD FORM (J61Z OPTION) (ACTIVE)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/dwg/ZA/ZA03F.pdf.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: http://www.fairchildsemi.com/packing_dwg/PKG-ZA03F.pdf.



Current Transfer Logic™



TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™ F-PFS™ AX-CAP®, **FRFET®** Global Power ResourceSM BitSiC™ Build it Now™ GreenBridge™ CorePLUS™ Green FPS™ CorePOWER™ Green FPS™ e-Series™ Gmax™ $CROSSVOLT^{\text{\tiny TM}}$ GTO™ $\mathsf{CTL}^{\mathsf{TM}}$

DEUXPEED[®] ISOPLANAR™
Dual Cool™ Making Small Speakers Sound Louder

IntelliMAX™

ECOSPARK® and Better™

EfficientMax™ MegaBuck™

ESBC™ MICROCOUPLEF

® MicroFET™

Fairchild®
Fairchild Semiconductor®
FACT Quiet Series™
FACT®
FAST®
FastvCore™

MicroPak™
MillerDrive™
MotionMax™
mWSaver®
OptoHiT™
Application
Applicatio

MegaBuck™
MICROCOUPLER™
MicroFET™
MicroPak™
MicroPak2™
MillerDrive™
MotionMax™
mWSaver®
OptoHiT™
OPTOLOGIC®
OPTOPLANAR®

PowerTrench[®] PowerXS™

Programmable Active Droop™

QFET[®]
QS™
Quiet Series™
RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS®
SyncFET™

Sync-LockTM
System
GENERAL®
TinyBoost®
TinyBuck®
TinyCalcTM
TinyLogic®
TINYOPTOTM
TinyPowerTM
TinyPWMTM
TinyPWMTM
TranSiCTM
TriFault DetectTM
TRUECURRENT®**

µSerDesTM

SerDes*
UHC®
Ultra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™

DISCLAIMER

FETBench™

FPS™

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN, NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

| Delinition of Terms | | |
|---------------------------------|-----------------------|---|
| Datasheet Identification | Product Status | Definition |
| Advance Information | Formative / In Design | Datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| Preliminary | First Production | Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design. |
| No Identification Needed | Full Production | Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design. |
| Obsolete | Not In Production | Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only. |

Rev. 166

^{*} Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

AMEYA360 Components Supply Platform

Authorized Distribution Brand:

























Website:

Welcome to visit www.ameya360.com

Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com